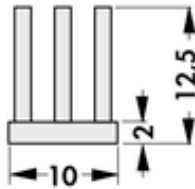
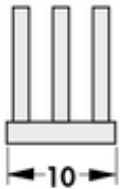
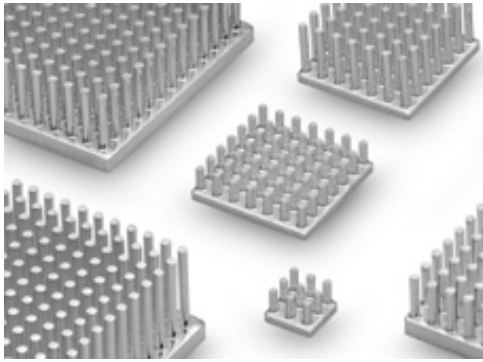


Pin heatsinks / **ICK S 10 x 10 x 12,5**

10 x 10 x 12,5 mm, pin heatsinks quadratic

Parameters of article ICK S 10 x 10 x 12,5

Bauform	Rechteck
R_{th} [K/W]	26.3
dissipation loss [W]	2.8
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
width [mm]	10
height [mm]	12.5
plate thickness [mm]	2
weight [g]	1.3
length on stock [mm]	10

Accessories/ related articles

Thermally conductive foil both sides adhesive / **WLFT 404 10 x 10**

Thermally conductive foil both sides adhesive / **WLFT 405 10 x 10**

